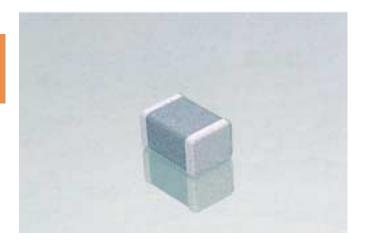
## COG (NP0) Dielectric

### **General Specifications**



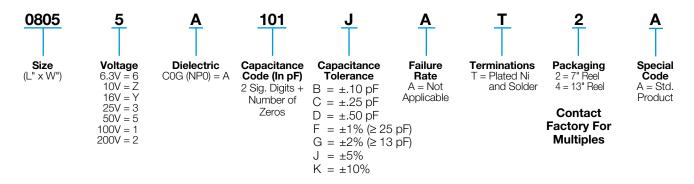


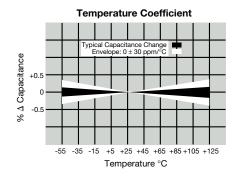
COG (NP0) is the most popular formulation of the "temperature-compensating," EIA Class I ceramic materials. Modern COG (NP0) formulations contain neodymium, samarium and other rare earth oxides.

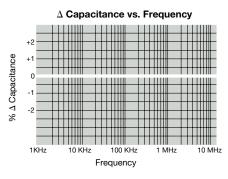
COG (NP0) ceramics offer one of the most stable capacitor dielectrics available. Capacitance change with temperature is 0  $\pm 30 ppm/^{\circ}C$  which is less than  $\pm 0.3\%$   $\Delta$  C from -55°C to +125°C. Capacitance drift or hysteresis for COG (NP0) ceramics is negligible at less than  $\pm 0.05\%$  versus up to  $\pm 2\%$  for films. Typical capacitance change with life is less than  $\pm 0.1\%$  for COG (NP0), one-fifth that shown by most other dielectrics. COG (NP0) formulations show no aging characteristics.

The COG (NP0) formulation usually has a "Q" in excess of 1000 and shows little capacitance or "Q" changes with frequency. Their dielectric absorption is typically less than 0.6% which is similar to mica and most films.

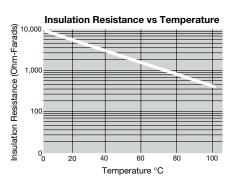
#### PART NUMBER (see page 2 for complete part number explanation)

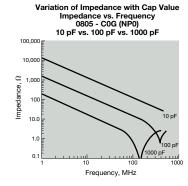


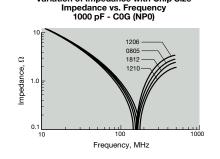


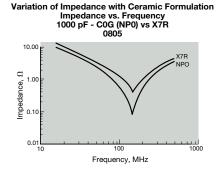


Variation of Impedance with Chip Size











# C0G (NP0) Dielectric



## **Specifications and Test Methods**

Parame		NP0 Specification Limits	Measuring Conditions						
Operating Temp		-55°C to +125°C	Temperature Cycle Chamber						
Capac	itance	Within specified tolerance	Freq.: 1.0 MHz ± 10% for cap ≤ 1000 pF						
d	<b>)</b>	<30 pF: Q≥ 400+20 x Cap Value	1.0 kHz ± 10% for cap > 1000 pF						
	•	≥30 pF: Q≥ 1000	Voltage: 1.0Vrms ± .2V  Charge device with rated voltage for						
Insulation I	Resistance	100,000ΜΩ or 1000ΜΩ - μF, whichever is less	60 ± 5 secs @ room temp/humidity						
		WHICHEVEL IS 1655	Charge device with 300% of rated voltage for						
Dielectric	Strength	No breakdown or visual defects	Charge device with 300% of rated voltage for 11-5 seconds, w/charge and discharge current						
Diologario	Ou ongui	140 bi dandowii di vidaal dolooto	limited to 50 mA (max)						
	Appearance	No defects	Deflection: 2mm						
	Capacitance	±5% or ±.5 pF, whichever is greater	Test Time: 30 seconds						
Resistance to	Variation	±3/0 Or ±.5 pr , Writchlever is greater	1mm/sec						
Flexure Stresses	Q	Meets Initial Values (As Above)	V						
	Insulation Resistance	≥ Initial Value x 0.3	90 mm —						
Solder	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic solder at 230 $\pm$ 5°C for 5.0 $\pm$ 0.5 seconds						
	Appearance	No defects, <25% leaching of either end terminal							
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Dip device in eutectic solder at 260°C for 60						
Resistance to Solder Heat	Q	Meets Initial Values (As Above)	seconds. Store at room temperature for 24 ± 2 hours before measuring electrical properties.						
Joidel Heat	Insulation Resistance	Meets Initial Values (As Above)							
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects	Step 1: -55°C ± 2° 30 ± 3 minutes						
	Capacitance Variation	$\leq$ ±2.5% or ±.25 pF, whichever is greater	Step 2: Room Temp ≤ 3 minutes						
Thermal Shock	Q	Meets Initial Values (As Above)	Step 3: +125°C ± 2° 30 ± 3 minutes						
SHOCK	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp ≤ 3 minutes						
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 hours at room temperature						
	Appearance	No visual defects							
	Capacitance	$\leq \pm 3.0\%$ or $\pm .3$ pF, whichever is greater							
	Variation		Charge device with twice rated voltage in						
Load Life	Q (C=Nominal Cap)	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C	test chamber set at 125°C ± 2°C for 1000 hours (+48, -0).  Remove from test chamber and stabilize at room temperature for 24 hours before measuring.						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)							
	Dielectric	Meets Initial Values (As Above)							
	Strength								
	Appearance	No visual defects							
	Capacitance Variation	$\leq$ ±5.0% or ± .5 pF, whichever is greater	Store in a test chamber set at 85°C $\pm$ 2°C/						
Load Humidity	Q	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C	85% ± 5% relative humidity for 1000 hours (+48, -0) with rated voltage applied.						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	Remove from chamber and stabilize at room temperature for 24 ± 2 hours before measuring.						
	Dielectric Strength	Meets Initial Values (As Above)							



## C0G (NP0) Dielectric



### **Capacitance Range**

#### **PREFERRED SIZES ARE SHADED**

									<b>E</b>																		
SIZE	<b>.</b>	0201			0201 0402			0603				0805					1206										
Solder	ing	Reflow Only			Only Reflow C			Reflow/Wave				Reflow/Wave					Reflow/Wave										
Packag	jing MM		All Paper 0.60 ± 0.03			All Paper 1.00 ± 0.10			All Paper 1.60 ± 0.15				Paper/Embossed 2.01 ± 0.20						er/Embo								
L) Length	(in.)	(0.0	(0.024 ± 0.001) 0.30 ± 0.03			$(0.040 \pm 0.004)$			$(0.063 \pm 0.006)$				$(0.079 \pm 0.008)$					(0.126 ± 0.008)									
(W) Width	MM (in.)		(0.011 ± 0.001)			0.50 ± 0.10 (0.020 ± 0.004)			0.81 ± 0.15 (0.032 ± 0.006)				1.25 ± 0.20 (0.049 ± 0.008)					1.60 ± 0.20 (0.063 ± 0.008)									
(t) Terminal	MM (in.)		$0.15 \pm 0.05$ (0.006 ± 0.002)			0.25 ± 0.15 (0.010 ± 0.006)			0.35 ± 0.15 (0.014 ± 0.006)					0.50 ± 0.25 020 ± 0.0			0.50 ± 0.25 (0.020 ± 0.010)										
WVD0	0	10	16	25	16	25	50	6.3	25	50	100	16	25	50	100	200	16	25	50	100	200						
Cap (pF)	0.5 1.0	A A	A A	A	СС	C	C	G G	G G	G G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	1.2 1.5	A	A A	A	C	C	C	G G	G G	G G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	1.8	A	Α	A	С	С	С	G	G	G	G	Е	Е	Е	Е	J	J	J	J	J	J						
	2.2 2.7	A A	A A	A	C	C	C	G G	G G	G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	3.3	Α	А	А	С	С	С	G	G	G	G	Е	Е	Е	Е	J	J	J	J	J	J						
	3.9 4.7	A A	A A	A	C	C	C	G G	G G	G G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	5.6 6.8	A A	A A	A A	C	C	C	G G	G G	G G	G G	E E	E E	E E	E E	J J	J	J	J	J J	J						
	8.2	Α	Α	А	С	С	С	G	G	G	G	Е	Е	Е	Е	J	J	J	J	J	J						
	10 12	A A	A A	A A	СС	C	C	G G	G G	G G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	15	Α	Α	Α	С	С	С	G	G	G	G	Е	Е	Е	Е	J	J	J	J	J	J						
	18 22	A A	A A	A A	C	C	C	G G	G G	G G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	27 33	A	A	A	C	C	C	G G	G G	G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	39	Α	Α		С	С	С	G	G	G	G	Е	Е	E	Е	J	J	J	J	J	J						
	47 56	A	A		C	C	C	G G	G	G	G	E E	E	E E	E	J	J	J	J	J	J						
	68 82	A A	А		C	C	C	G G	G G	G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	100	A			С	С	С	G	G	G	G	Е	Е	Е	Е	J	J	J	J	J	J						
	120 150				C	C	C	G G	G G	G	G G	E E	E E	E E	E E	J	J	J	J	J	J						
	180				С	С	С	G	G	G	G	Е	Е	Е	Е	J	J	J	J	J	J						
	220 270				C	С	С	G G	G G	G	G G	E E	E E	E E	E J	J M	J	J	J	J	J						
	330 390				С			G G	G G	G G	G	E	E	E J	J	M M	J	J	J	J J	J						
	470							G	G	G		Ĵ	Ĵ	J	J	M	Ĵ	J	J	J	J						
	560 680							G G	G G	G G		J	J	J	J		J	J	J	J	J						
	820 1000							G G	G G	G		J	J	J	J		J	J	J	J	M Q						
	1200							G	l d	l G		J	J	J	J		J	J	J	J	Q						
	1500 1800							G G				J	J	J			J	J	J M	M	Q						
	2200											J	J	М			J	J	M	P P							
	2700 3300											J N	J N	М			J	J	M	Р							
	3900 4700											N N	N N				J	J	M M	P P							
	5600						İ				N					J	J	М									
	6800 8200		ا	-[-]	$\sim$	W-	•					N N					M M	M M									
Cap (µF)	0.010 0.012		~				ŢT					N					М	М									
/h-: /	0.015		'				_										М										
	0.018 0.022				t																						
	0.027 0.033																										
	0.039																										
	0.047 0.068																$\vdash$										
	0.082 0.1																										
WVD0	0	10	16	25	16	25	50	6.3	25	50	100	16	25	50	100	200	16	25	50	100	200						
SIZE			0201		0402		0603					0805					1206										
Letter Max.	<b>A</b> 0.33		C         E         G         J           0.56         0.71         0.86         0.94		<b>J</b> 0.94	<b>K</b>		<b>M</b> .27	<b>N</b>	1.5		<b>Q</b> 1.78	<b>X</b> 2.29		<b>Y</b>	<b>Z</b> 2.79		<b>BB CC</b> 3.05 3.175									
Thickness	(0.013)		(0.022) (0.028)								(0.03		0.94	(0.040		050)	(0.055)	(0.06		0.070)	(0.090		.100)	(0.110)	(0.1		(0.125)
			ı	PAPER																							

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# C0G (NP0) Dielectric



### **Capacitance Range**

#### PREFERRED SIZES ARE SHADED

		П					TI											
SIZE			210			18	12			1825			2220		2225			
Soldering			//Wave		Reflow Only				Reflow Only			R	eflow Onl	V	Reflow Only			
Packaging		Paper/Ei	mbossed			All Emb	ossed		All Embossed			All	Embosse	ed	All Embossed			
(L) Length MM (in.)			± 0.20 ± 0.008)			4.50 ± (0.177 ±			4.50 ± 0.30 (0.177 ± 0.012)				5.70 ± 0.40 224 ± 0.016		5.72 ± 0.25 (0.225 ± 0.010)			
(W) Width MM (in.)		2.50	± 0.20 ± 0.008)			3.20 ± (0.126 ±	0.20			6.40 ± 0.40 0.252 ± 0.0	)	5	5.00 ± 0.40 197 ± 0.016		6.35 ± 0.25 (0.250 ± 0.010)			
(t) Terminal MM		0.50	± 0.25			0.61 ±	0.36			0.61 ± 0.36	3	(	0.64 ± 0.39		0.64 ± 0.39			
WVDC (in.)	(0.020 ± 0.010) 25 50 100 200			(0.024 ± 0.014) 25 50 100 200				50	0.024 ± 0.01	200	50	025 ± 0.018	200	(0.025 ± 0.015) 50 100 200				
Cap 0.5 (pF) 1.0 1.2 1.5																		
1.8 2.2 2.7 3.3																	N 1	
3.9 4.7 5.6																		
6.8 8.2 10															*t	1 T		
12 15 18	-																	
22 27 33	-																	
39 47 56	-																	
68 82 100	-																	
120 150 180	-																	
220 270 330	-																	
390 470 560	J	J	J	J														
680 820 1000	J	J	J	J	K K	K K	K K	K K	M	M M	M	X	X	X	P	P	P	
1200 1500 1800 2200	J	J	J J M	M M Q	K K	K K K	K K K	K K K	M M M	M M M	M M M	X X X	X X X	X X X	P P P	PPP	P	
2700 3300 3900	J	J	M M M	ğ	K K K	K K K	K K K	P	M M M	M M M	M M M	X X X	X X X	X	P P P	P P P	P	
4700 5600 6800	J	J	M		K K K	K M M	M M	P	M M M	M M M	M M M	X X X	X X X	X X X	P P P	P P P	P P P	
8200 Cap 0.010 (μF) 0.012	N	J N N			K K K	P P P	X X X	X X	M M M	M M M		X X X	X X X	X X X X	P P P	P P P	P P P	
0.015 0.018 0.022	-				M M M	P P CC CC	X		P P P	M		X X X	X X X	X	P P P	P P Y	Y Y Y	
0.027 0.033 0.039	1				M M M	CC CC CC			P P P			X	X		P P P	Y	Y Y Y	
0.047 0.068 0.082					CC CC CC	CC CC CC			P						P P P			
WVDC 0.1	25	50	100	200	25	50	100	200	50	100	200	50	100	200	P 50	100	200	
SIZE			1210			1812			1825			2220			2225			
Letter A Max. 0.33	0.56	6 0.	.71	<b>G</b> 0.86	0.94 (0.037)	1.02 (0.040)	1.27 (0.05	7 1.	N .40	1.52	Q 1.78 (0.070)	2.29 (0.000)	2.54 (0.10	4 2.	<b>Z</b>	3.05	3.175 (0.125)	
Thickness (0.013	(0.02	, ,	028) ( PER	0.034)	(0.037)	(0.040)	(0.05	0) [ (0.)	055) (	(0.060)	(0.070) EMBC	(0.090) <b>DSSED</b>	(0.10	0.	110) (	0.120)	(0.125)	

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